

# DATA SHEET

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## 74LVC573A

Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

Product specification

1998 Jul 29

## Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

### 74LVC573A

#### FEATURES

- 5-volt tolerant inputs/outputs, for interfacing with 5-volt logic
- Supply voltage range of 2.7V to 3.6V
- Complies with JEDEC standard no. 8-1A
- Inputs accept voltages up to 5.5V
- CMOS low power consumption
- Direct interface with TTL levels
- High impedance when  $V_{CC} = 0V$
- Flow-through pin-out architecture

#### DESCRIPTION

The 74LVC573A is a high-performance, low-power, low-voltage, Si-gate CMOS device, superior to most advanced CMOS compatible TTL families.

Inputs can be driven from either 3.3V or 5V devices. In 3-State operation, outputs can handle 5V. This feature allows the use of these devices as translators in a mixed 3.3V/5V environment.

The 74LVC573A is an octal D-type transparent latch featuring separate D-type inputs for each latch and 3-State outputs for bus-oriented applications. A latch enable (LE) input and an output enable ( $\overline{OE}$ ) input are common to all internal latches.

The '573A' consists of eight D-type transparent latches with 3-State true outputs. When LE is HIGH, data at the  $D_n$  inputs enters the latches. In this condition, the latches are transparent, i.e. a latch output will change each time its corresponding D-input changes. When LE is LOW, the latches store the information that was present at the D-inputs one setup time preceding the HIGH-to-LOW transition of LE. When  $\overline{OE}$  is LOW, the contents of the eight latches are available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go to the high impedance OFF-state. Operation of the  $\overline{OE}$  input does not affect the state of the latches.

The '573A' is functionally identical to the '373A', but the '373A' has a different pin arrangement.

#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
$t_{PHL}/t_{PLH}$	Propagation delay $D_n$ to $Q_n$ ; LE to $Q_n$	$C_L = 50pF$ $V_{CC} = 3.3V$	4.3 4.6	ns
$C_I$	Input capacitance		5.0	pF
$C_{PD}$	Power dissipation capacitance per latch	Notes 1 and 2	20	pF

#### NOTE:

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ):  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  $C_L$  = output load capacity in pF;  
 $f_o$  = output frequency in MHz;  $V_{CC}$  = supply voltage in V;  
 $\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.
2. The condition is  $V_I = GND$  to  $V_{CC}$

#### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
20-Pin Plastic Shrink Small Outline (SO)	-40°C to +85°C	74LVC573A D	74LVC573A D	SOT163-1
20-Pin Plastic Shrink Small Outline (SSOP) Type II	-40°C to +85°C	74LVC573A DB	74LVC573A DB	SOT339-1
20-Pin Plastic Thin Shrink Small Outline (TSSOP) Type I	-40°C to +85°C	74LVC573A PW	7LVC573APW DH	SOT360-1

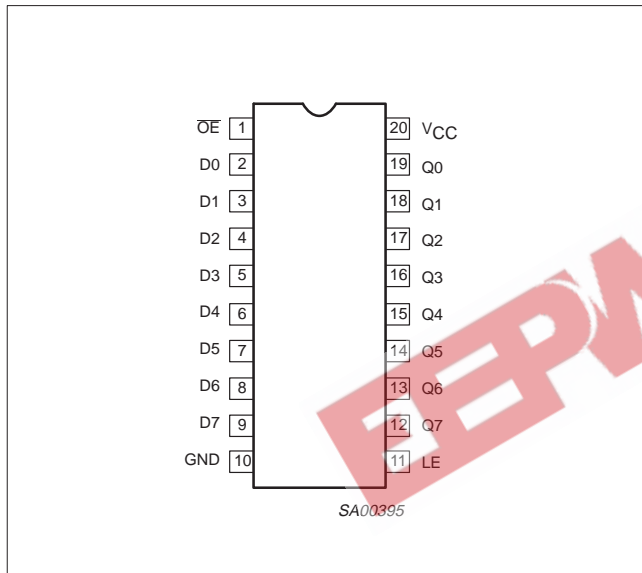
# Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

74LVC573A

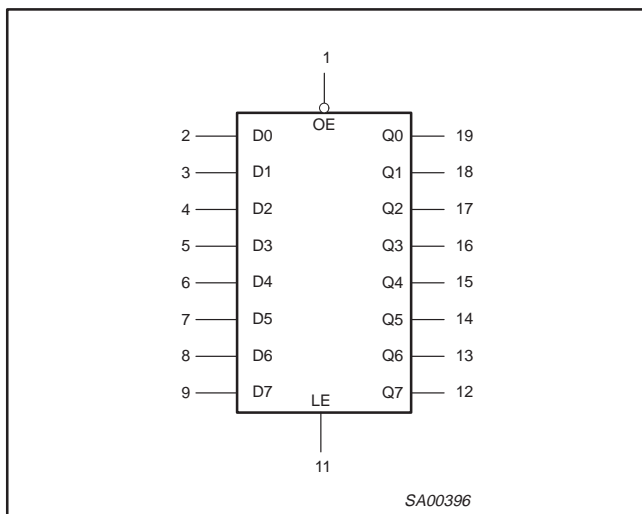
## PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	$\overline{OE}$	Output enable input (active-Low)
2, 3, 4, 5, 6, 7, 8, 9	D0-D7	Data inputs
19, 18, 17, 16, 15, 14, 13, 12	Q0-Q7	Data outputs
10	GND	Ground (0V)
11	LE	Latch enable input (active-High)
20	V <sub>CC</sub>	Positive supply voltage

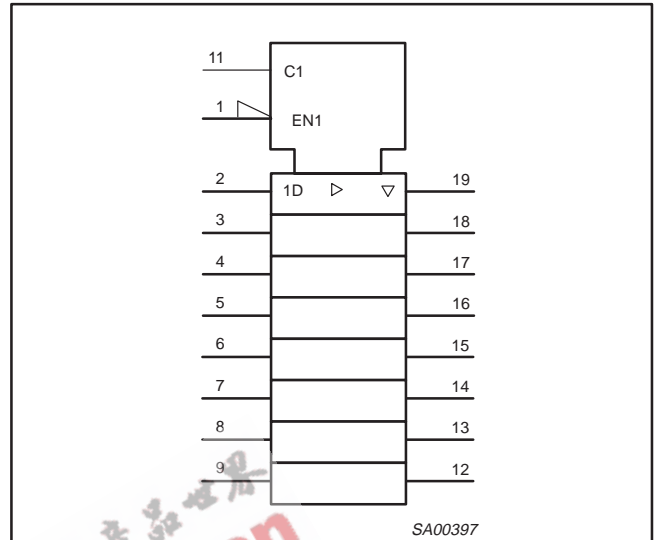
## PIN CONFIGURATION



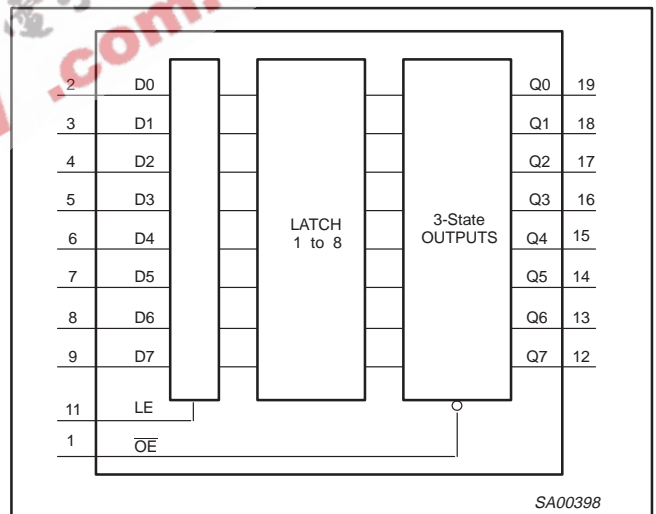
## LOGIC SYMBOL



## LOGIC SYMBOL (IEEE/IEC)



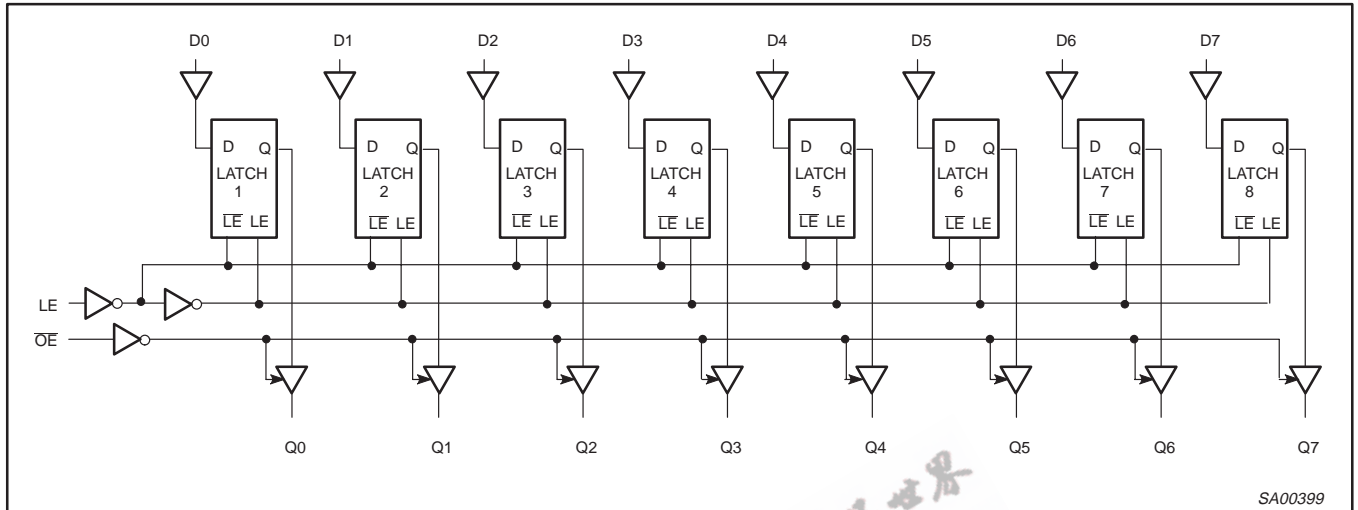
## FUNCTIONAL DIAGRAM



# Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

74LVC573A

## LOGIC DIAGRAM



## FUNCTION TABLE

OPERATING MODES	INPUTS			INTERNAL LATCHES	OUTPUTS
	$\overline{OE}$	LE	$D_n$		$Q_0$ to $Q_7$
Enable and read register (transparent mode)	L	H	L	L	L
	L	H	H	H	H
Latch and read register	L	L	l	L	L
	L	L	h	H	H
Latch register and disable outputs	H	L	l	L	Z
	H	L	h	H	Z

H = HIGH voltage level  
 h = HIGH voltage level one setup time prior to the HIGH-to-LOW LE transition  
 L = LOW voltage level  
 l = LOW voltage level one setup time prior to the HIGH-to-LOW LE transition  
 X = Don't care  
 Z = High impedance OFF-state

# Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

74LVC573A

## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIMITS		UNIT
			MIN	MAX	
V <sub>CC</sub>	DC supply voltage (for max. speed performance)		2.7	3.6	V
	DC supply voltage (for low-voltage applications)		1.2	3.6	
V <sub>I</sub>	DC Input voltage range		0	5.5	V
V <sub>O</sub>	DC output voltage range; output HIGH or LOW state		0	V <sub>CC</sub>	V
	DC output voltage range; output 3-State		0	5.5	
T <sub>amb</sub>	Operating ambient temperature range in free-air		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input rise and fall times	V <sub>CC</sub> = 1.2 to 2.7V V <sub>CC</sub> = 2.7 to 3.6V	0 0	20 10	ns/V

## ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

In accordance with the Absolute Maximum Rating System (IEC 134)  
Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +6.5	V
I <sub>IK</sub>	DC input diode current	V <sub>I</sub> < 0	-50	mA
V <sub>I</sub>	DC input voltage	Note 2	-0.5 to +6.5	V
I <sub>OK</sub>	DC output diode current	V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0	± 50	mA
V <sub>O</sub>	DC output voltage; output HIGH or LOW state	Note 2	-0.5 to V <sub>CC</sub> + 0.5	V
	DC output voltage; output 3-State	Note 2	-0.5 to 6.5	
I <sub>O</sub>	DC output source or sink current	V <sub>O</sub> = 0 to V <sub>CC</sub>	± 50	mA
I <sub>GND</sub> , I <sub>CC</sub>	DC V <sub>CC</sub> or GND current		± 100	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
P <sub>TOT</sub>	Power dissipation per package			
	- plastic mini-pack (SO) - plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	500 500	mW

### NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

74LVC573A

## DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			Temp = -40°C to +85°C			
			MIN	TYP <sup>1</sup>	MAX	
V <sub>IH</sub>	HIGH level Input voltage	V <sub>CC</sub> = 1.2V	V <sub>CC</sub>			V
		V <sub>CC</sub> = 2.7 to 3.6V	2.0			
V <sub>IL</sub>	LOW level Input voltage	V <sub>CC</sub> = 1.2V			GND	V
		V <sub>CC</sub> = 2.7 to 3.6V			0.8	
V <sub>OH</sub>	HIGH level output voltage	V <sub>CC</sub> = 2.7V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = -12mA	V <sub>CC</sub> - 0.5			V
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = -100μA	V <sub>CC</sub> - 0.2	V <sub>CC</sub>		
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = -18mA	V <sub>CC</sub> - 0.6			
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = -24mA	V <sub>CC</sub> - 0.8			
V <sub>OL</sub>	LOW level output voltage	V <sub>CC</sub> = 2.7V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 12mA			0.40	V
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 100μA		GND	0.20	
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 24mA			0.55	
I <sub>I</sub>	Input leakage current <sup>2</sup>	V <sub>CC</sub> = 3.6V; V <sub>I</sub> = 5.5V or GND		±0.1	±5	μA
I <sub>OZ</sub>	3-State output OFF-state current	V <sub>CC</sub> = 3.6V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = 5.5V or GND		0.1	±10	μA
I <sub>off</sub>	Power off leakage supply	V <sub>CC</sub> = 0.0V; V <sub>I</sub> or V <sub>O</sub> = 5.5V		0.1	±10	μA
I <sub>CC</sub>	Quiescent supply current	V <sub>CC</sub> = 3.6V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0		0.1	10	μA
ΔI <sub>CC</sub>	Additional quiescent supply current per input pin	V <sub>CC</sub> = 2.7V to 3.6V; V <sub>I</sub> = V <sub>CC</sub> - 0.6V; I <sub>O</sub> = 0		5	500	μA

### NOTES:

- All typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.
- The specified overdrive current at the data input forces the data input to the opposite logic input state.

## AC CHARACTERISTICS

GND = 0V; t<sub>r</sub> = t<sub>f</sub> ≤ 2.5ns; C<sub>L</sub> = 50pF; R<sub>L</sub> = 500Ω; T<sub>amb</sub> = -40°C to +85°C.

SYMBOL	PARAMETER	WAVEFORM	LIMITS						UNIT
			V <sub>CC</sub> = 3.3V ±0.3V			V <sub>CC</sub> = 2.7V		V <sub>CC</sub> = 1.2V	
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	TYP	
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation delay D <sub>n</sub> to Q <sub>n</sub>	1, 5	1.5	4.3	6.2	1.5	7.2	19	ns
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation delay LE to Q <sub>n</sub>	2, 5	1.5	4.6	6.5	1.5	7.5	21	ns
t <sub>PZH</sub> t <sub>PZL</sub>	3-State output enable time OE to Q <sub>n</sub>	2, 5	1.5	3.8	7.5	1.5	8.5	17	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	3-State output disable time OE to Q <sub>n</sub>	3, 5	1.5	3.5	6.0	1.5	6.5	15	ns
t <sub>W</sub>	LE pulse width HIGH	2	3.2	1.6	–	3.2	–	–	ns
t <sub>SU</sub>	Setup time D <sub>n</sub> to LE	4	1.7	0.3	–	1.7	–	–	ns
t <sub>H</sub>	Hold time D <sub>n</sub> to LE	4	1.4	0.2	–	1.5	–	–	ns

### NOTE:

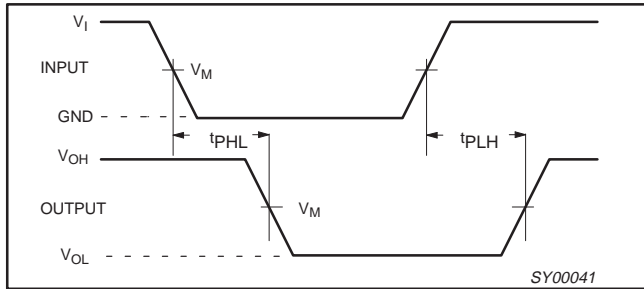
- Unless otherwise stated, all typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.

# Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

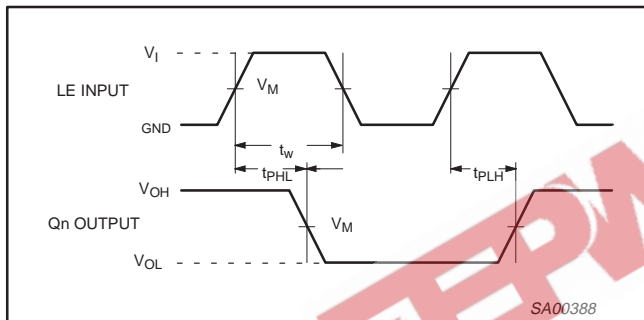
74LVC573A

## AC WAVEFORMS

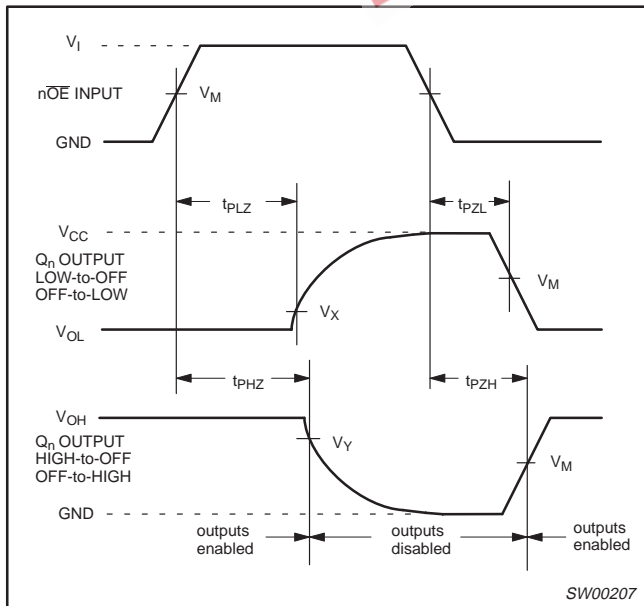
$V_M = 1.5V$  at  $V_{CC} \geq 2.7V$ ;  $V_M = 0.5 V_{CC}$  at  $V_{CC} < 2.7V$ .  
 $V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.  
 $V_X = V_{OL} + 0.3V$  at  $V_{CC} \geq 2.7V$ ;  $V_X = V_{OL} + 0.1 V_{CC}$  at  $V_{CC} < 2.7V$   
 $V_Y = V_{OH} - 0.3V$  at  $V_{CC} \geq 2.7V$ ;  $V_Y = V_{OH} - 0.1 V_{CC}$  at  $V_{CC} < 2.7V$



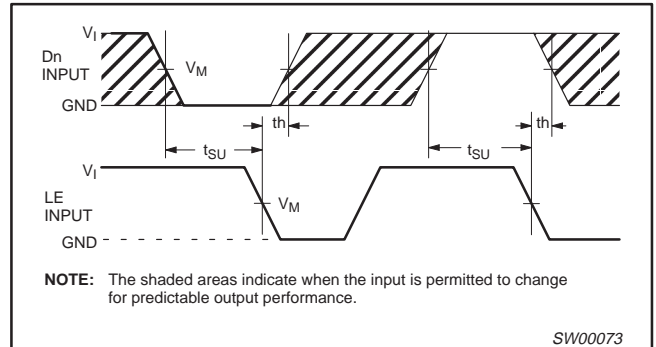
Waveform 1. Input ( $D_n$ ) to output ( $Q_n$ ) propagation delays.



Waveform 2. Latch enable input (LE) pulse width, the latch enable input to output ( $Q_n$ ) propagation delays

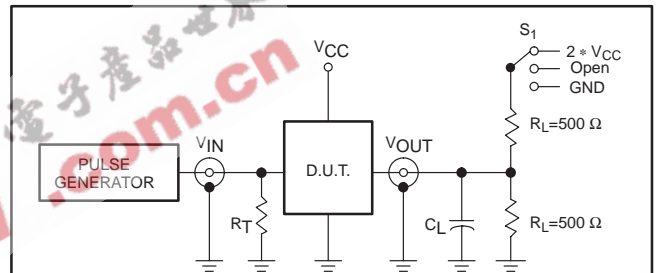


Waveform 3. 3-State enable and disable times.



Waveform 4. Data setup and hold times for the  $D_n$  input to the LE input.

## TEST CIRCUIT



Test Circuit for 3-State Outputs

### SWITCH POSITION

TEST	SWITCH
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	$2 * V_{CC}$
$t_{PHZ}/t_{PZH}$	GND

$V_{CC}$	$V_{IN}$
$< 2.7V$	$V_{CC}$
$2.7 - 3.6V$	$2.7V$

### DEFINITIONS

$R_L$  = Load resistor  
 $C_L$  = Load capacitance includes jig and probe capacitance  
 $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.

SW00047

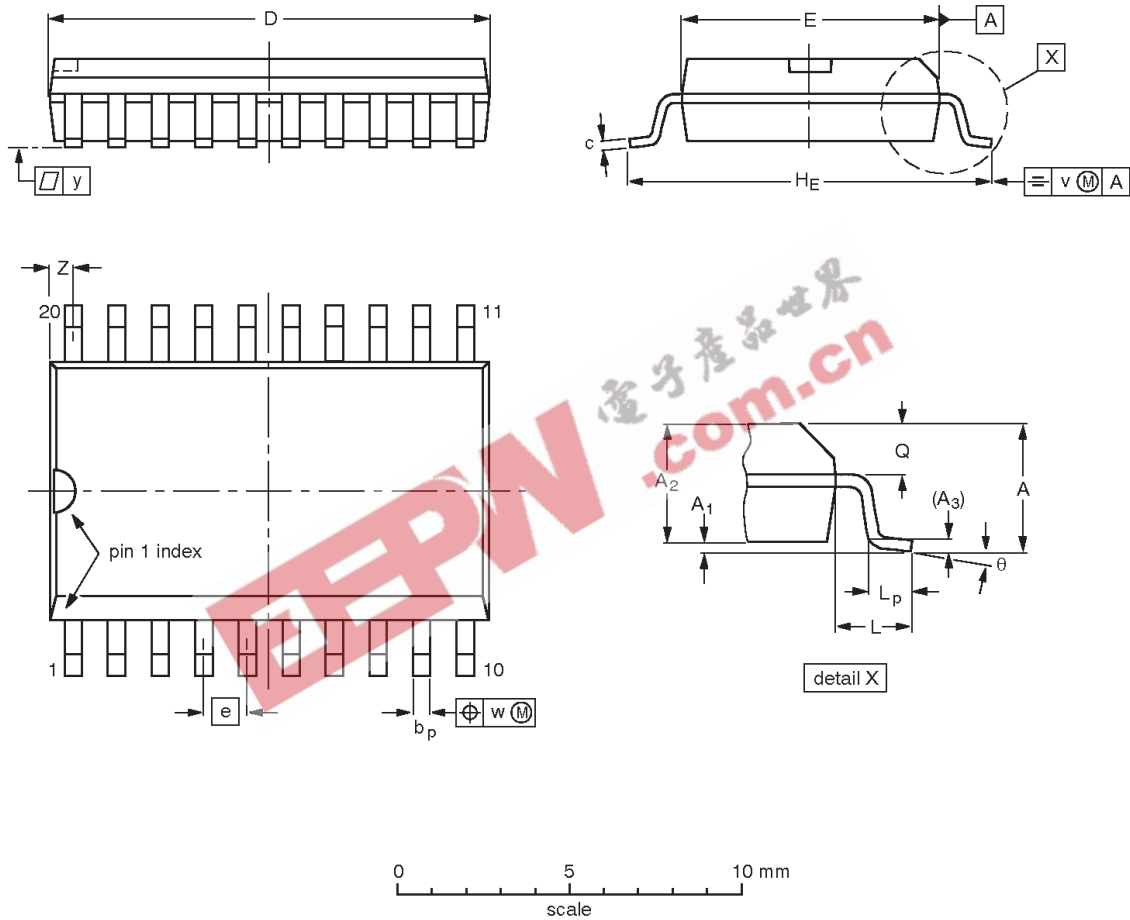
Waveform 5. Load circuitry for switching times.

Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

74LVC573A

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT163-1	075E04	MS-013AC				95-01-24 97-05-22

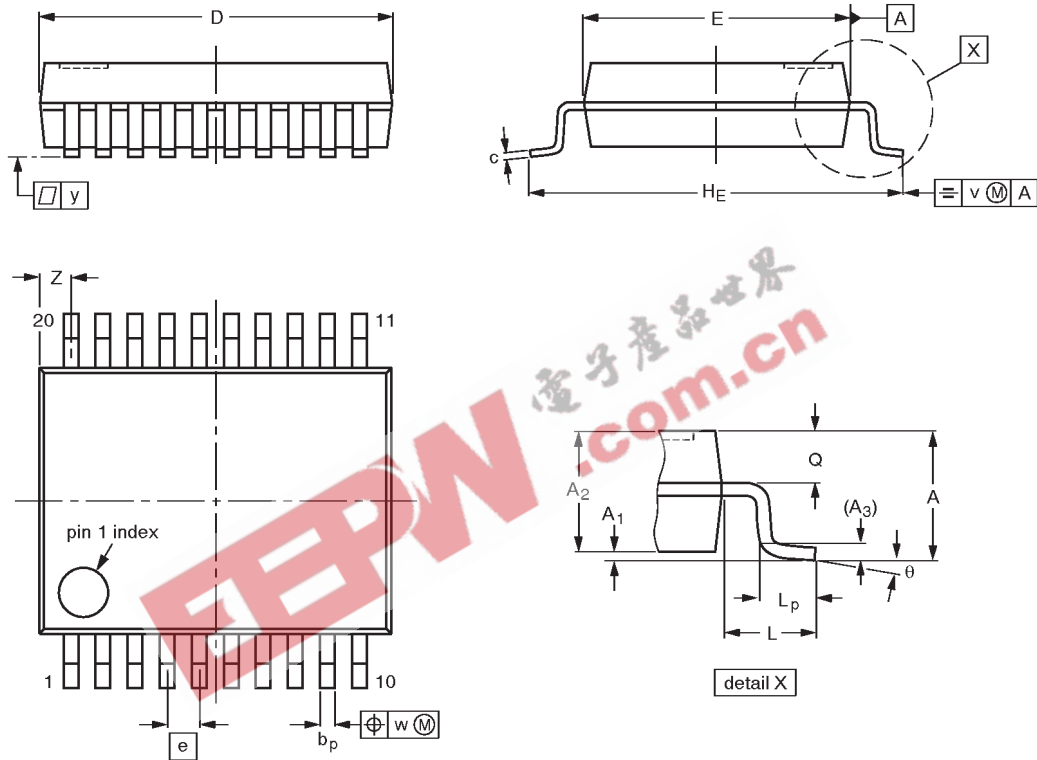


Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

74LVC573A

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

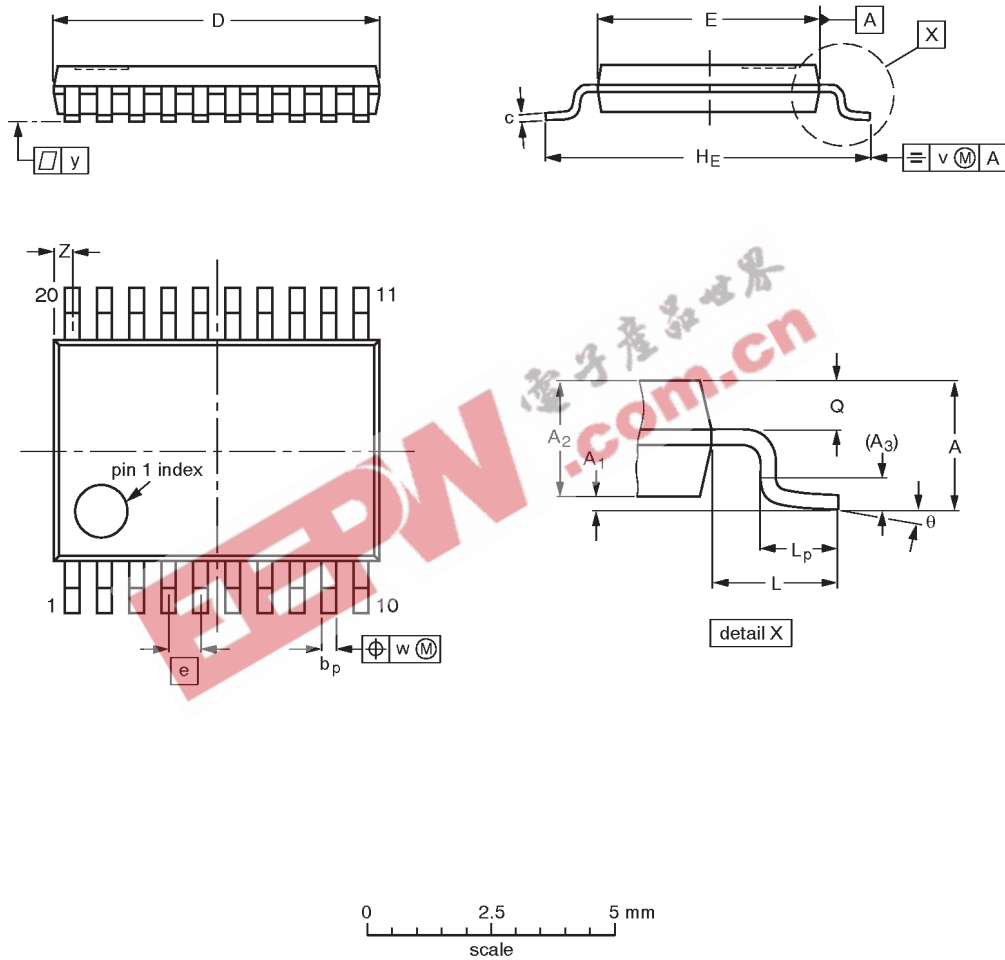
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT339-1		MO-150AE				93-09-08 95-02-04

Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

74LVC573A

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT360-1		MO-153AC				93-06-16 95-02-04

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Octal D-type transparent latch with 5-volt  
tolerant inputs/outputs (3-State)

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74LVC573A

NOTES



# Octal D-type transparent latch with 5-volt tolerant inputs/outputs (3-State)

74LVC573A

## Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

## Definitions

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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